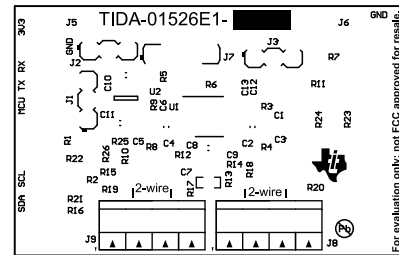
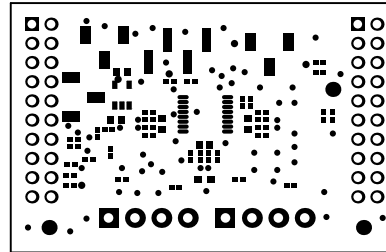


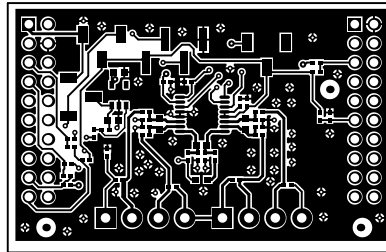
Logot



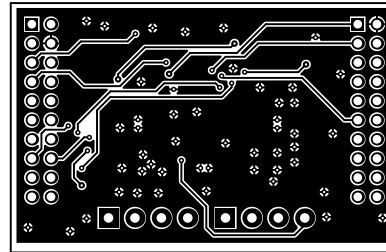
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-01526	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME = Top Overlay	TID #:	TIDA-01526				
PLOT NAME = Top Overlay	GENERATED	: 7/25/2017	1:47:10 PM	TEXAS INSTRUMENTS		



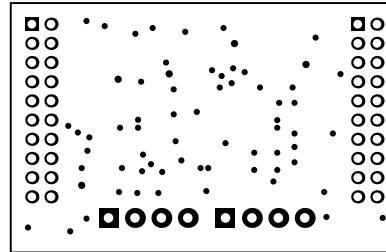
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01526		
PLOT NAME = Top Solder Mask	GENERATED : 7/25/2017 1:47:12 PM	TEXAS INSTRUMENTS	



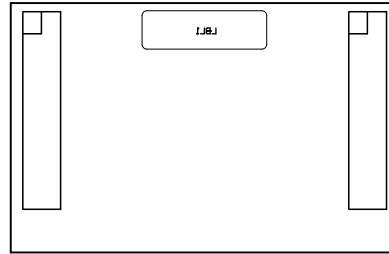
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01526		
PLOT NAME = Top Layer	GENERATED : 7/25/2017 1:47:13 PM	TEXAS INSTRUMENTS	



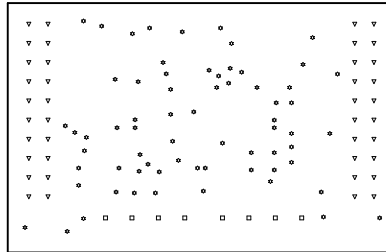
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01526		
PLOT NAME = Bottom Layer	GENERATED : 7/25/2017 1:47:15 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01526		
PLOT NAME = Bottom Solder Mask	GENERATED : 7/25/2017 1:47:16 PM	TEXAS INSTRUMENTS	

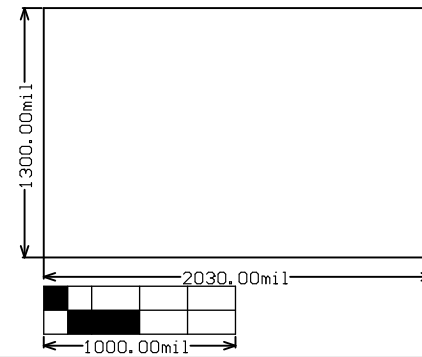


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01526		
PLOT NAME = Bottom Overlay	GENERATED : 7/25/2017 1:47:18 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
★	67	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
▽	40	45.28mil (1.150mm)	PTH	Round	Top Layer - Bottom Layer	
□	8	50.00mil (1.270mm)	PTH	Round	Top Layer - Bottom Layer	
	115 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01526		
PLOT NAME = Drill Drawing	GENERATED : 7/25/2017	1:47:19 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01526	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01526		
PLOT NAME = Board Dimensions	GENERATED : 7/25/2017	1:47:21 PM	TEXAS INSTRUMENTS



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